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UNITED STATES PATENT APPLICATION

FOR

SYSTEM AND METHOD OF PRINTING ON THERMOCHROMIC FILM

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SYSTEM AND METHOD OF PRINTING ON THERMOCHROMIC FILM

FIELD

The invention generally relates to the field of thermal image generation. In particular, one embodiment of the invention relates to a system and technique for altering a surface of a thermochromic film to form graphical representations that are temporarily visible until the thermochromic film returns to its normal, ambient temperature.

GENERAL BACKGROUND

Over the past few decades, efforts have been made to conserve our national resources. While it is now commonplace for residential communities to participate in recycling programs, greater strides in conservation are now necessary for businesses. For example, in order to reduce wasteful usage of paper and other costly office supplies, more and more businesses are providing employees with erasable illustrative aids such as blackboards and whiteboards. However, these illustrative aids require a person to manually write or draw an image directly on to the illustrative aid.

Currently, printers normally use ink or toner cartridges that permanently print a graphical representation on paper or plastic slides. Even thermal

printers generate graphical representations that a permanent until erased by a thermal heating process. These printing mechanisms are unable to temporarily produce a graphical representation (e.g., text or image) on a surface without user activity and that automatically fades away after a prescribed period of time.

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BRIEF DESCRIPTION OF THE DRAWINGS

The features and advantages of the invention will become apparent from the following detailed description of the invention in which:

5 Figure 1 is an exemplary block diagram of a first embodiment of a thermal image generation device operating as a distributed node of a network.

10 Figure 2 is an exemplary block diagram of a second embodiment of the thermal image generation device operating as a dedicated output device of a computing unit.

15 Figures 3A and 3B are exemplary block diagrams of a detailed embodiment of the thermal image generation device of Figure 1 or 2 with a thermochromic film positioned adjacent to a cover.

Figure 4 is an exemplary block diagram of an embodiment of logic employed within the thermal image generation device of Figures 3A and 3B.

20 Figure 5 is an exemplary block diagram of an embodiment of a thermal transfer element of the thermal image generation device of Figure 1.

Figure 6 is an exemplary block diagram of another detailed embodiment of the thermal image generation device

42390P11967-3

of Figures 1 or 2 with thermochromic micro-capsules embedded into the material forming the cover.

Figure 7 is an exemplary block diagram of an embodiment of a product adapted to receive an external
5 add-on device made in part with thermochromic micro-capsules to represent different operational states of the product.

Figure 8 is an exemplary flowchart of the operations of the invention.

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DETAILED DESCRIPTION

In general, one embodiment of the invention relates to a thermal image generation device and its associated method for visually altering a thermochromic material

5 (e.g., a thermochromic film) in response to a change in temperature until the thermochromic material returns to its ambient temperature. For one embodiment, the visual alteration causes graphical representations, namely text and/or images, to be temporarily visible on the
10 thermochromic material.

Herein, certain details are set forth in order to provide a thorough understanding of the invention. Of course, it is contemplated that the invention may be practiced through many embodiments other than those
15 illustrated. Well-known circuits and operations are not set forth in detail in order to avoid unnecessarily obscuring the present invention.

Referring to Figure 1, an exemplary block diagram of a first embodiment of a thermal image generation device
20 operating as a distributed node of a network is shown. One example of the thermal image generation device includes a writing tablet of any size or configuration. Of course, this embodiment is for illustrative purposes and other embodiments may incorporate the inventive
25 aspects described herein.

Configured as a local area network (LAN) or as a wide area network (WAN), the network 100 comprises a link 110 interconnecting one or more ($N \geq 1$) computers 120₁-120_N (e.g., desktop, a laptop, a hand-held, a server, a workstation, etc.). The link 110 is an information-carrying medium (e.g., electrical wire, optical fiber, cable, bus, or air in combination with wireless signaling technology) that is adapted to establish communication pathways between the computers 120₁-120_N and a thermal image generation device 130.

As shown, the thermal image generation device 130 operates as a centralized output device, which is adapted with logic, namely hardware, firmware, software module(s) or any combination thereof. Herein, a "software module" is a series of code instructions that, when executed, performs a certain function. Examples of such code include an operating system, an application, an applet, a program or even a subroutine. Software module(s) may be stored in a machine-readable medium, including but not limited to an electronic circuit, a semiconductor memory device, a read only memory (ROM), a flash memory, an erasable ROM (EROM), a floppy diskette, a compact disk, an optical disk, a hard disk, a fiber optic medium, a radio frequency (RF) link and the like.

Referring now to Figure 2, an exemplary block diagram of a second embodiment of the thermal image generation device 130 operating as a dedicated output device such as a writing tablet is shown. The thermal image generation device 130 is coupled to a computer 200 over a dedicated link 210. This enables information to be downloaded from the computer 200 to the thermal image generation device 130. As an alternative, the thermal image generation device 130 may be configured as an input/output (I/O) device for uploading information to the computer 200 as represented by a dashed arrow. This may be accomplished by implementing the thermal image generation device 130 with a touch screen, keypad or another input mechanism.

Referring to Figures 3A and 3B, exemplary block diagrams of a detailed embodiment of the thermal image generation device 130 of Figures 1 or 2 is shown. The thermal image generation device 130 comprises a casing 300 made of a rigid material such as hardened plastic. The casing 300 provides a cavity for housing logic (e.g., thermal transfer element(s), processor, thermal sensor(s), etc.) and protecting such logic from damage caused by environmental conditions. One surface 310 of the casing 300 features a screen 320 made of a semi-opaque material having a transparent or translucent quality (e.g., glass, plastic, etc.).

A thermochromic film 330 is attached to the screen 320. As shown in Figure 3B, for this embodiment, the thermochromic film 330 is applied to a bottom surface 325 of the screen 320 by a lamination process. Of course, 5 other application techniques may be utilized.

Referring back to Figure 3A, a side surface 315 of the casing 300 enables a connector port 340 to be accessible through the casing 300. For instance, in one embodiment, the connector port 340 may be configured to 10 receive an adapter to the link 110 (e.g., Ethernet adapter) that enables communications over the network 100 as shown in Figure 1. Alternatively, the connector port 340 may include a serial port, a parallel port or a Universal Serial Bus (USB) port for communications with 15 the computer 200 of Figure 2 or even a wireless receiver or transceiver (e.g., light emitting diode "LED" detector, a radio frequency "RF" receiver or transceiver, etc.). Of course, multiple connector ports may be provided to support different types of adapters.

20 In response to applying a temperature to a region 335 of the thermochromic film 330, this temperature differing from its ambient temperature (T_a) by a temperature difference (T_1), the thermochromic film 330 within the region 335 experiences a color variation. The color 25 variation may be applied in any chosen pattern to

represent an image, alphanumeric character, a reference point or any other graphical representation, depending on the manner in which changes in temperature ($T_a \pm T_1$) are applied to the thermochromic film 330. For instance, the temperature difference T_1 may be greater than or equal to one degree Celsius ($\geq 1^\circ\text{C}$)

Referring to Figure 4, an exemplary block diagram of an embodiment of logic within the casing 300 of the thermal image generation device 130 of Figures 3A and 3B is shown. The logic 400 comprises a processor 410, a driver circuit 420, a thermal transfer element 430 and a sensor 440. In response to information downloaded from a remote source (e.g., computer) or retrieved from internal memory situated within the casing 300, the processor 410 controls the driver circuit 420. The driver circuit 420 activates and controls the thermal transfer element 430 so as to alter the temperature of certain regions of the thermochromic film from its ambient temperature (T_a) to a resultant temperature ($T_a \pm T_1$).

Herein, for one embodiment, the driving circuit 420 may be a light source (e.g., light emitting diode, laser, etc.). For this embodiment, the heat transfer element 430 is generally a light beam produced by the light source and a combination of filters and lenses, which adjust the light beam.

Alternatively, the driving circuit 420 may be a voltage and/or current regulator to adjust the voltage and/or current realized by the thermal transfer element 430. For this embodiment, the thermal transfer element 5 430 may be adapted as a single thermal element such as a semiconductor or an impedance component (e.g., a resistor, inductor, potentiometer, capacitor, etc.).

Where the thermal transfer element 430 is effectively a light beam produced by a combination of filters (e.g., 10 Fresnel lens) and lenses, the adjustment of the light beam may be controlled by mechanical logic 435. For this embodiment, the mechanical logic 435 includes, but is not limited or restricted to mirror(s) controlled by galvanometers. Also, the mechanical logic 435 may provide 15 feedback regarding the direction of the light beam deflected by the positioning of the mirror(s) over link 450.

Where the thermal transfer element 430 is employed as an impedance component, the mechanical logic 435 enables 20 placement of the thermal transfer element 430 along an X, Y axial region bounded by the perimeter of thermochromic film proximate to the screen 320 of Figures 3A and 3B. For instance, the mechanical logic 435 may be a roller assembly having an array of thermal elements (see Figure 25 5) that controls Y-axis placement of the array along the

thermochromic film 330. Alternatively, the mechanical logic 435 may be an assembly that enables one or more thermal elements to be independently positioned anywhere along the thermochromic film 330. The mechanical logic 5 435 provides feedback regarding the X and/or Y-axis screen position of the thermal transfer elements.

The sensor 440 regulates the temperature applied to the region 335 and provides such information to the processor 410 over link 460. Upon receipt of the feedback 10 information from the sensor 440, the processor 410 responds accordingly by controlling the mechanical logic 435 to alter placement of the thermal transfer element 430, the driver circuit 420 to activate/deactivate the thermal transfer element 430 or a combination thereof.

15 Referring to Figure 5, an exemplary block diagram of an embodiment of the thermal transfer element utilized within the thermal image generation device 130 is shown. The thermal transfer element 430 includes an array of thermal elements 500 that are laterally spaced apart (X- 20 axis) and adjacent to the thermochromic film 330. Namely, the array 500 forms a single row of thermal elements 510₁-510_C (where "C" \geq 1). Such spacing is static in nature and may extend across the entire width of the thermochromic film 330 or along a particular region 335 as illustrated 25 in Figures 3A and 3B.

The mechanical logic 435 adjusts the longitudinal (Y-axis) placement of the array of thermal elements 500.

While the mechanical logic 435 controls the longitudinal movement, each thermal element 510₁-510_c is discreetly
5 controlled by the driving circuit 420. The combination of mechanical movement and thermal element control will enable a graphical representation (e.g., text, image, etc.) to be displayed temporarily on the thermochromic film 330 . In addition, one or more thermal sensors
10 (e.g., sensors 520₁-510_c) may be employed to regulate the temperature of a corresponding thermal elements 510₁-510_M.

Another embodiment may include a static array of thermal elements (not shown). The array may be arrange to form a numbers of rows (R , $R_{\geq 1}$) and columns (C , $C_{\geq 1}$).

- 15 Each thermal element 510₁-510_c may have a corresponding thermal sensor 520₁-520_c. Each thermal element 510₁-510_c would be under discreet control. This implementation would not have any mechanical assembly to control placement of a single array of thermal elements as
20 described above.

It is contemplated that a thermal removing device (e.g., a heat sink) 530 may be coupled as part of the logic 400 of Figures 4 and 5 to assist in returning thermochromic film 330 back to ambient room temperature.

This will assist the thermochromic film 330 in changing back to ambient color state in a timely fashion.

Referring now to Figure 6, an exemplary block diagram of another detailed embodiment of the thermal image

5 generation device 130 of Figures 1 or 2 is shown. In lieu of a screen/film combination 320, 330 of Figures 3A and 3B, material forming the screen 600 is also embedded with thermochromic micro-capsules 610. In response to a region 620 of the screen 600 experiencing a change in temperature
10 (T1) from its ambient temperature (Ta), namely the application of a resultant temperature ($Ta \pm T1$) to the region 620, the thermochromic micro-capsules 610 within that region 620 experience a color variation. The color variation experienced by these thermochromic micro-
15 capsules 610 is temporary and returns to its normal color as the resultant temperature returns to the ambient temperature (Ta).

Referring now to Figure 7, an exemplary block diagram of an embodiment of a product adapted with integrated
20 components and/or with attachable components made in part with thermochromic micro-capsules is shown. For instance, the integrated component 700 and/or attachable component 710 are injected molded plastic elements formed with a thermal transfer element 720 and 730, respectively. Each

of the thermal transfer elements 720 and 730 may be one or more impedance elements.

In one embodiment, in response to a certain condition (e.g., power up, correct depression of a button, etc.), the thermal transfer element 720 is configured to receive current from internal logic 740 within the product 750. This causes the thermal transfer element 720 to generate additional thermal heat, which results in the thermochromic material within the integrated component 700 changing color. The same or even a different event may cause the internal logic 740 to apply current to the thermal transfer element 730 of the attachable component 710.

Of course, in response to a certain condition (e.g., power-off, incorrect depression of a button, etc.), the internal logic 740 may discontinue current supplied to the thermal transfer elements 720 and/or 730, which returns the thermochromic material within the components 700 and/or 710 to its ambient temperature and color.

Referring now to Figure 8, an exemplary flowchart of the operations of the invention is shown. In response to a condition (e.g., power up, depression of a button, etc.), a thermal transfer element is activated to alter the temperature of thermochromic material (blocks 800 and 810). The thermochromic material may be an entire sheet

of thermochromic film or a particular region,
thermochromic material mixed with other material as a
composite and the like.

One or more sensors are used to monitor the
5 temperature of the thermochromic material in order to
determine whether it has experienced a sufficient
temperature difference to alter the color of the
thermochromic material (blocks 820 and 830). For example,
for this embodiment, the sensor(s) may be used to
10 determine if the temperature of the thermochromic material
has risen above or fallen below its ambient temperature
(Ta) by a selected temperature difference (T1) causing the
thermochromic material to change color (block 840).

The sensor(s) also periodically monitor if the
15 temperature of the thermochromic material has risen above
a maximum temperature or fallen below a minimum
temperature (block 850). Also, the sensor(s) monitor
whether temperature of the thermochromic material has
remained at this temperature for a prescribed period of
20 time (block 860). Upon confirming that at least one of
these events has occurred, the thermal transfer element
may now be deactivated (block 870). This would allow
gradual fading of the displayed graphical representation
as the thermochromic material returns to its ambient
25 temperature.

Such deactivation may be to substantially reduce current applied to and/or voltage realized by one or more thermal elements being impedance elements. Where the thermal transfer element is a light beam, deactivation is accomplished by discontinuing or deflecting the light beam.

Alternatively, if the maximum or minimum temperature has not been met or exceeded, the thermal transfer element may continue to be activated or periodically throttled between an activated and deactivated state in order to retain the displayed graphical representation. The thermal transfer element may be deactivated in response to an affirmative action by the user (e.g., depress button, power-off, etc.). It is contemplated that a thermal removing device may be used in combination to more quickly return the thermochromic material back to its approximate ambient temperature.

While certain exemplary embodiments have been described and shown in the accompanying drawings, it is to be understood that such embodiments are merely illustrative of and not restrictive on the broad invention, and that this invention not be limited to the specific constructions and arrangements shown and described. For example, it may be possible to implement

the invention or some of its features in hardware,
firmware, software or a combination thereof.

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